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RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RA2E1

DEVICE : R7FA2E1XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-1000 V, 1 time	0/3	Class: 1C
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78 Pulse Current Injection, I=+/-150 mA		0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-1000 V, 1 time	0/3	Class: 1C
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (BGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $℃$ to 125 $ℂ$, 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-1000 V, 1 time	0/3	Class: 1C
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ to 125 $^{\circ}$, 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-1000 V, 1 time	0/3	Class: 1C
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

^{*1)} With preconditioning per JESD22-A113, MSL 3

Note .

[•]It is tested to confirm that all the samples are satisfied with an individual product specification.



The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 4.1 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term (π T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV)
Ta: Ambient temperature (℃)

π T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

·MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$



Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG
Wafer level chip scale package	WLCSP	SxBG

^{*1.} First four digit

Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RA2E1	R7FA2E1A72DBU	PVBG0064L*	51	C.Gup	i roddet part riamber	r dellage code
2	RA2E1	R7FA2E1A73CBU	PVBG0064L*	52			
3	RA2E1	R7FA2E1A92DBU	PVBG0064L*	53			
4	RA2E1	R7FA2E1A93CBU	PVBG0064L*	54			
5	RA2E1	R7FA2E1A52DFJ	PLQP0032G*	55			
6	RA2E1	R7FA2E1A53CFJ	PLQP0032G*	56			
7	RA2E1	R7FA2E1A72DFJ	PLQP0032G*	57			
8	RA2E1	R7FA2E1A73CFJ	PLQP0032G*	58			
9	RA2E1	R7FA2E1A92DFJ	PLQP0032G*	59			
10	RA2E1	R7FA2E1A93CFJ	PLQP0032G*	60			
11	RA2E1	R7FA2E1A72DFK	PLQP0064G*	61			
12	RA2E1	R7FA2E1A73CFK	PLQP0064G*	62			
13	RA2E1	R7FA2E1A92DFK	PLQP0064G*	63			
14	RA2E1	R7FA2E1A93CFK	PLQP0064G*	64			
15	RA2E1	R7FA2E1A52DFL	PLQP0048K*	65			
16	RA2E1	R7FA2E1A53CFL	PLQP0048K*	66			
17	RA2E1	R7FA2E1A72DFL	PLQP0048K*	67			
18	RA2E1	R7FA2E1A73CFL	PLQP0048K*	68			
19	RA2E1	R7FA2E1A92DFL	PLQP0048K*	69			
20	RA2E1	R7FA2E1A93CFL	PLQP0048K*	70			
21	RA2E1	R7FA2E1A72DFM	PLQP0064K*	71			
22	RA2E1	R7FA2E1A73CFM	PLQP0064K*	72			
23	RA2E1	R7FA2E1A92DFM	PLQP0064K*	73			
24	RA2E1	R7FA2E1A93CFM	PLQP0064K*	74			
25	RA2E1	R7FA2E1A52DLM	PWLG0036K*	75			
26	RA2E1	R7FA2E1A53CLM	PWLG0036K*	76			
27	RA2E1	R7FA2E1A72DLM	PWLG0036K*	77			
28	RA2E1	R7FA2E1A73CLM	PWLG0036K*	78			
29	RA2E1	R7FA2E1A92DLM	PWLG0036K*	79			
30	RA2E1	R7FA2E1A93CLM	PWLG0036K*	80			
31	RA2E1	R7FA2E1A72DNB	PWQN0064L*	81			
32	RA2E1	R7FA2E1A73CNB	PWQN0064L*	82			
33	RA2E1	R7FA2E1A92DNB	PWQN0064L*	83			
34	RA2E1	R7FA2E1A93CNB	PWQN0064L*	84			
35	RA2E1	R7FA2E1A52DNE	PWQN0048K*	85			
36	RA2E1	R7FA2E1A53CNE	PWQN0048K*	86			
37	RA2E1	R7FA2E1A72DNE	PWQN0048K*	87			
38	RA2E1	R7FA2E1A73CNE	PWQN0048K*	88			
39	RA2E1	R7FA2E1A92DNE	PWQN0048K*	89			
40	RA2E1	R7FA2E1A93CNE	PWQN0048K*	90			
41	RA2E1	R7FA2E1A52DNH	PWQN0032K*	91			
42	RA2E1	R7FA2E1A53CNH	PWQN0032K*	92			
43	RA2E1	R7FA2E1A72DNH	PWQN0032K*	93			
44	RA2E1	R7FA2E1A73CNH	PWQN0032K*	94			
45	RA2E1	R7FA2E1A92DNH	PWQN0032K*	95			
46	RA2E1	R7FA2E1A93CNH	PWQN0032K*	96			
47				97			
48				98			
49				99			
50				100			